

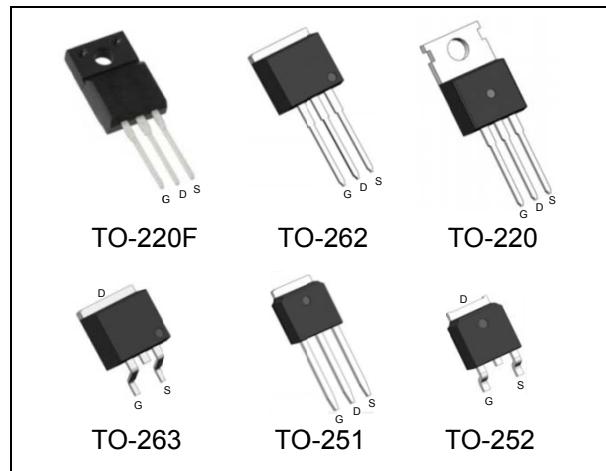
650V 0.33Ω Super Junction Power MOSFET

Description

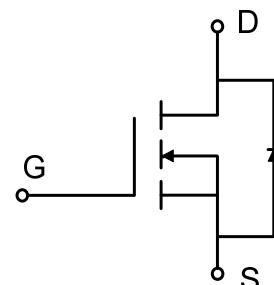
WMOS™ C4 is Wayon's 4th generation super junction MOSFET family that is utilizing charge balance technology for extremely low on-resistance and low gate charge performance. WMOS™ C4 is suitable for applications which require superior power density and outstanding efficiency.

Features

- $V_{DS} = 700V @ T_{j,max}$
- Typ. $R_{DS(on)} = 0.33\Omega$
- 100% UIS tested
- Pb-free plating, Halogen free

**Applications**

LED Lighting, Charger, Adapter, PC, LCD TV, Server

**Absolute Maximum Ratings**

Parameter	Symbol	WMK/WMM/WMO/WMP/WMN	WML	Unit
Drain-source voltage	V_{DSS}	650		V
Continuous drain current ¹⁾ ($T_C = 25^\circ C$)	I_D	11		A
($T_C = 100^\circ C$)		6		A
Pulsed drain current ²⁾	I_{DM}	26		A
Gate-source voltage	V_{GS}	± 30		V
Avalanche energy, single pulse ³⁾	E_{AS}	115		mJ
Avalanche energy, repetitive ²⁾	E_{AR}	0.15		mJ
Avalanche current, repetitive ²⁾	I_{AR}	1.5		A
Power dissipation ($T_C = 25^\circ C$)	P_D	85	31	W
- Derate above 25°C		0.68	0.25	W/°C
Operating and storage temperature range	T_j, T_{stg}	-55 to +150		°C
Continuous diode forward current	I_S	11		A
Diode pulse current	$I_{S,pulse}$	26		A

Thermal Characteristics

Parameter	Symbol	WMK/WMM/WMO/WMP/WMN	WML	Unit
Thermal resistance, junction-to-case	$R_{\theta JC}$	1.47	4	°C/W
Thermal resistance, junction-to-ambient	$R_{\theta JA}$	62	80	°C/W

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}}=0 \text{ V}, I_{\text{D}}=0.25 \text{ mA}$	650	-	-	V
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=0.25 \text{ mA}$	2	3	4	V
Drain cut-off current	I_{DSS}	$V_{\text{DS}}=650 \text{ V}, V_{\text{GS}}=0 \text{ V},$ $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	-	-	1	μA
Gate leakage current, forward	I_{GSSF}	$V_{\text{GS}}=20 \text{ V}, V_{\text{DS}}=0 \text{ V}$	-	-	100	nA
Gate leakage current, reverse	I_{GSSR}	$V_{\text{GS}}=-20 \text{ V}, V_{\text{DS}}=0 \text{ V}$	-	-	-100	nA
Drain-source on-state resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10 \text{ V}, I_{\text{D}}=2.5 \text{ A}$ $T_j = 25^\circ\text{C}$	-	0.33	0.38	Ω
Dynamic characteristics						
Input capacitance	C_{iss}	$V_{\text{DS}}=100 \text{ V}, V_{\text{GS}}=0 \text{ V},$ $f = 1 \text{ MHz}$	-	665	-	pF
Output capacitance	C_{oss}		-	21.5	-	
Reverse transfer capacitance	C_{rss}		-	2.3	-	
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 300 \text{ V}, I_{\text{D}} = 3 \text{ A}$ $R_G = 25 \Omega, V_{\text{GS}} = 10 \text{ V}$	-	17	-	ns
Rise time	t_r		-	17	-	
Turn-off delay time	$t_{\text{d}(\text{off})}$		-	62	-	
Fall time	t_f		-	16	-	
Gate charge characteristics						
Gate to source charge	Q_{gs}	$V_{\text{DD}} = 480 \text{ V}, I_{\text{D}} = 3 \text{ A},$ $V_{\text{GS}} = 0 \text{ to } 10 \text{ V}$	-	2.9	-	nC
Gate to drain charge	Q_{gd}		-	4.5	-	
Gate charge total	Q_g		-	13	-	
Gate plateau voltage	V_{plateau}		-	5.0	-	V
Reverse diode characteristics						
Diode forward voltage	V_{SD}	$V_{\text{GS}}=0 \text{ V}, I_{\text{F}}=2.5 \text{ A}$	-	-	1.2	V
Reverse recovery time	t_{rr}	$V_R = 50 \text{ V}, I_{\text{F}} = 3 \text{ A},$ $dI_{\text{F}}/dt = 100 \text{ A}/\mu\text{s}$	-	170	-	ns
Reverse recovery charge	Q_{rr}		-	1.4	-	μC
Peak reverse recovery current	I_{rrm}		-	17	-	A

Notes:

1. Limited by $T_{j\max}$. Maximum duty cycle D=0.5.
2. Repetitive rating: pulse width limited by maximum junction temperature.
3. $I_{AS} = 1.5 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$, starting $T_j = 25^\circ\text{C}$.

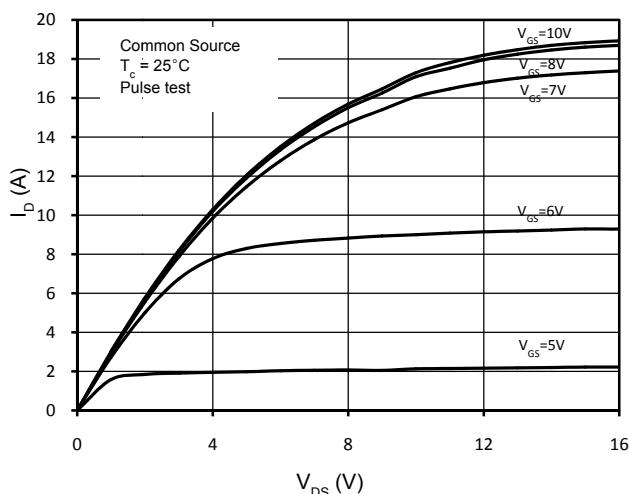


Figure 1. On-Region Characteristics

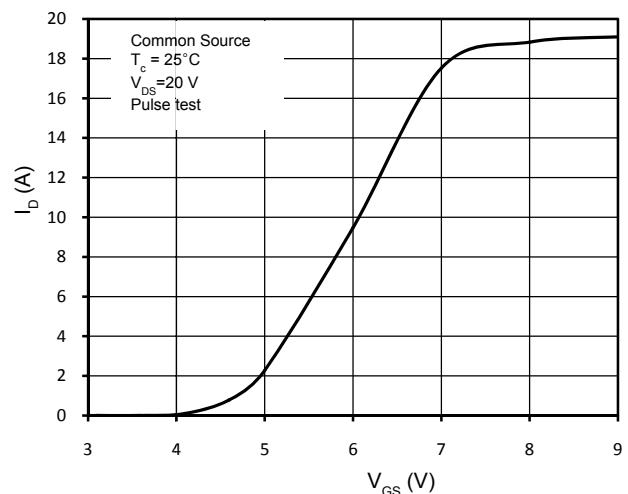


Figure 2. Transfer Characteristics

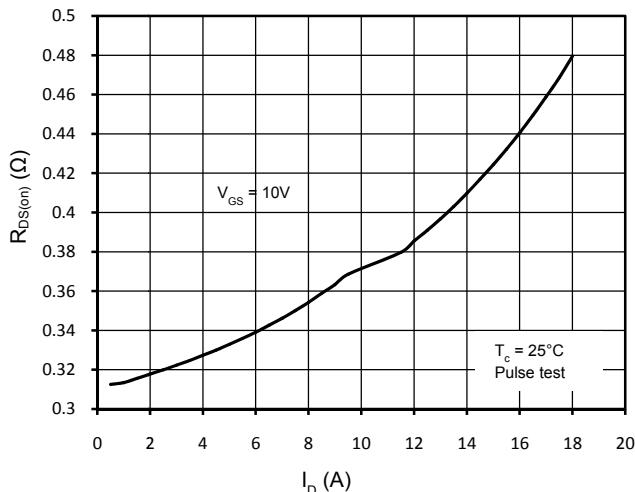


Figure 3. Static Drain-Source On Resistance

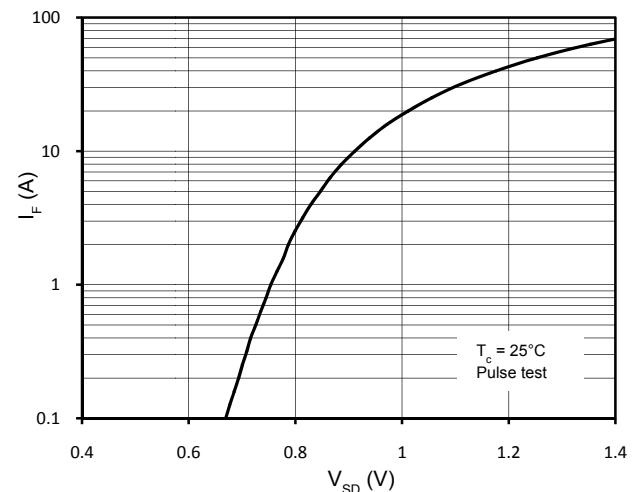
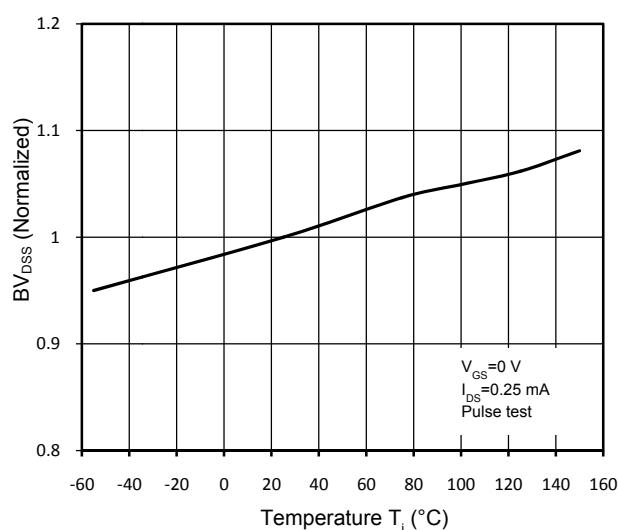
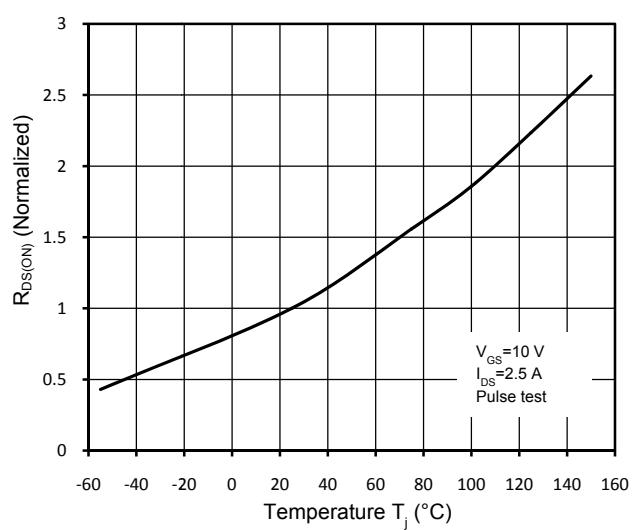


Figure 4. Body-Diode Forward Characteristics

Figure 5. Normalized BV_{DSS} vs. TemperatureFigure 6. Normalized R_{DS(on)} vs. Temperature

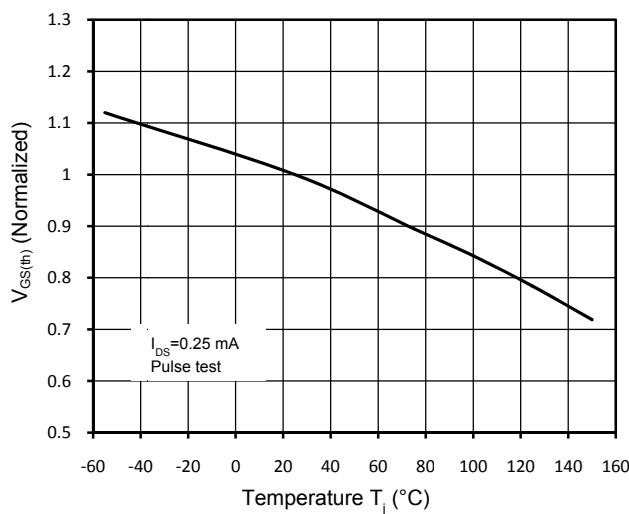


Figure 7. Threshold Voltage vs. Temperature

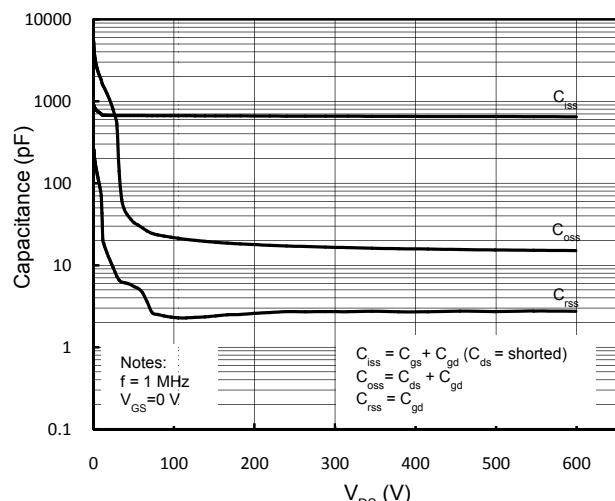


Figure 8. Capacitance Characteristics

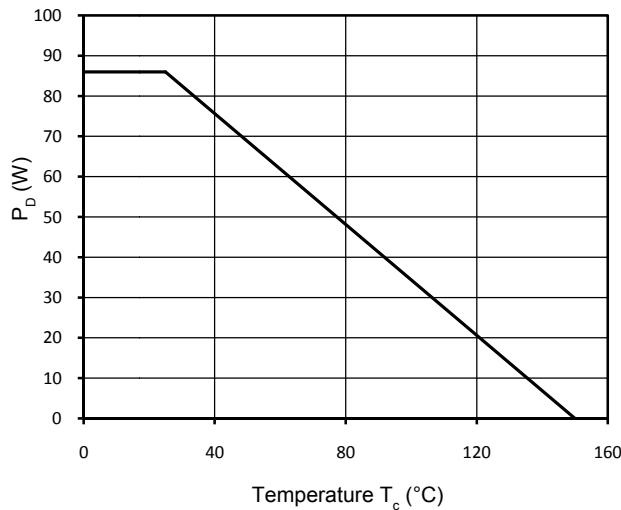


Figure 9. Power Dissipation

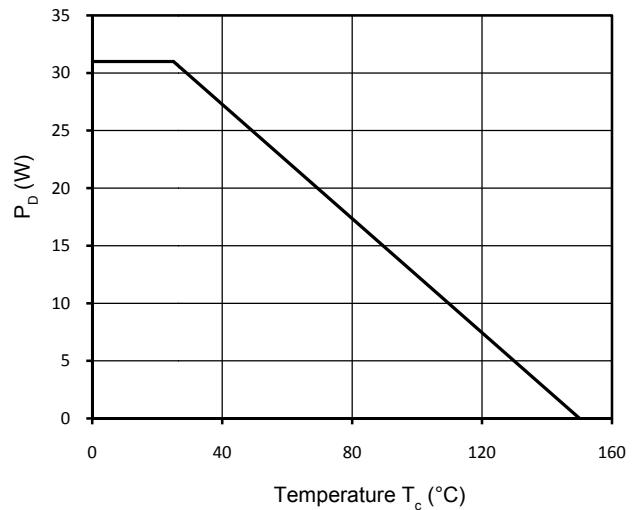


Figure 10. Power Dissipation (TO-220F)

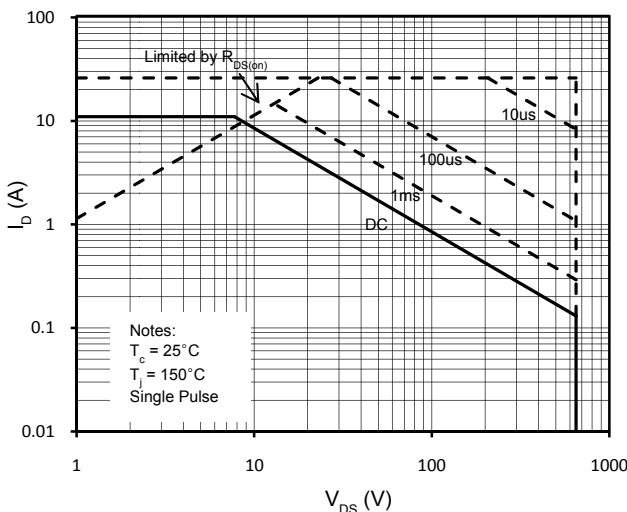


Figure 11. Maximum Safe Operating Area

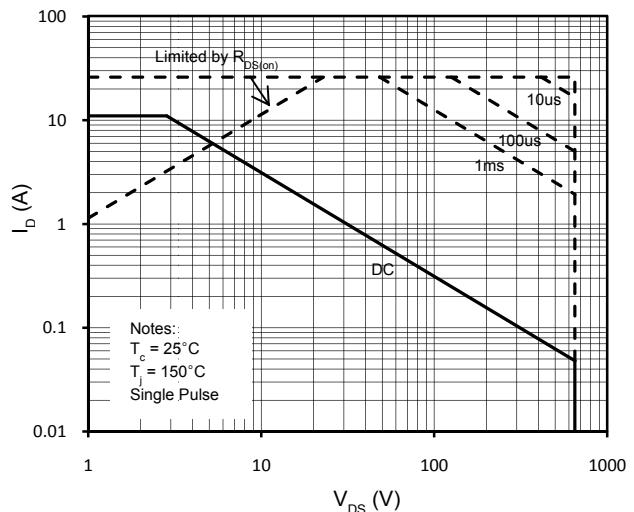


Figure 12. Maximum Safe Operating Area(TO-220F)

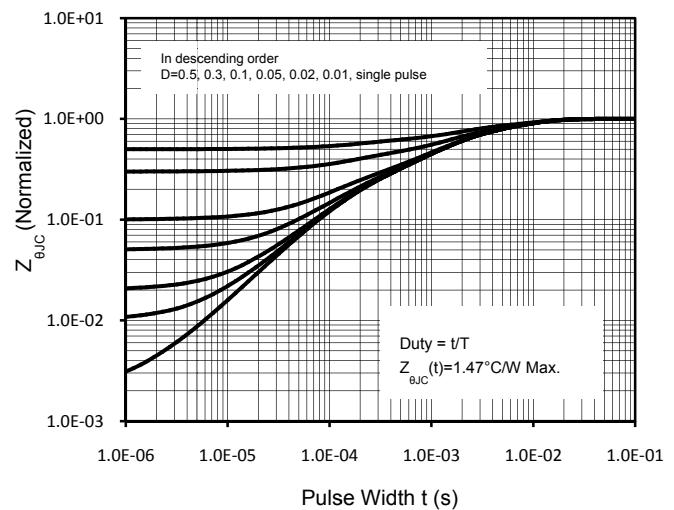
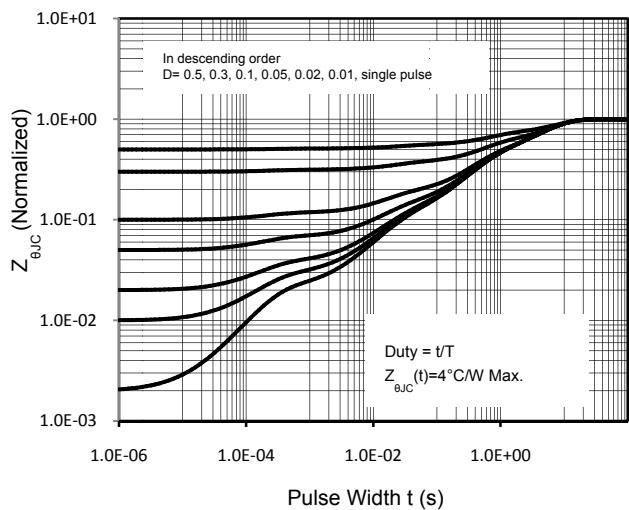


Figure 13. Transient Thermal Response Curve (TO-220F) Figure 14. Transient Thermal Response Curve

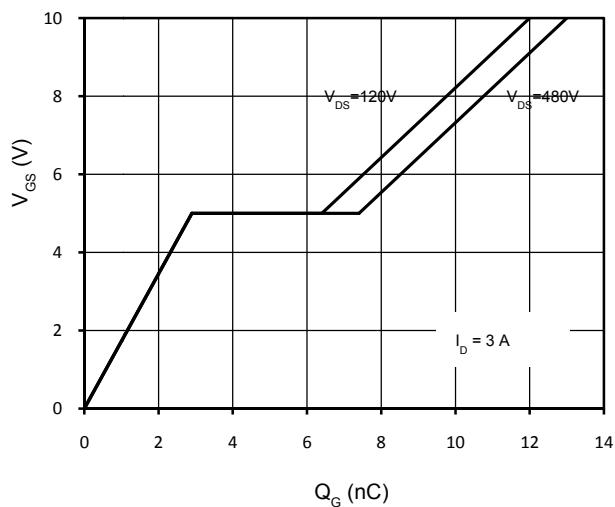
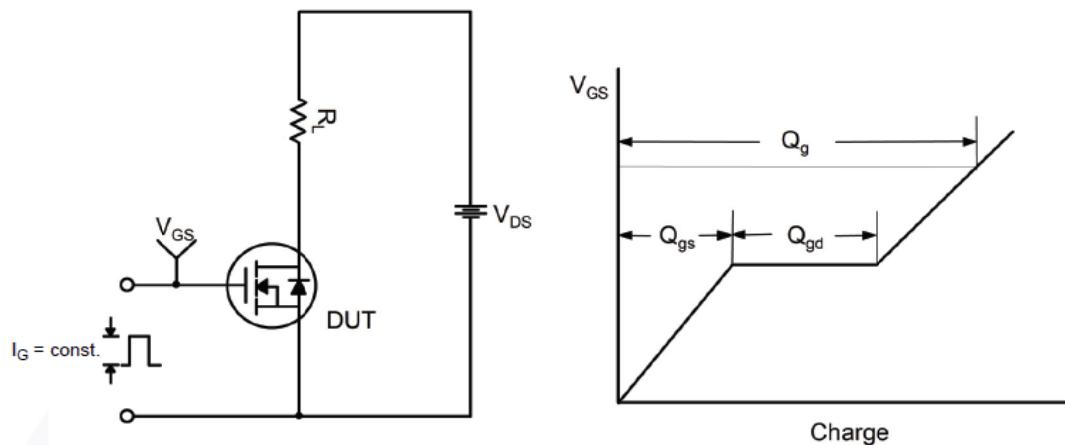
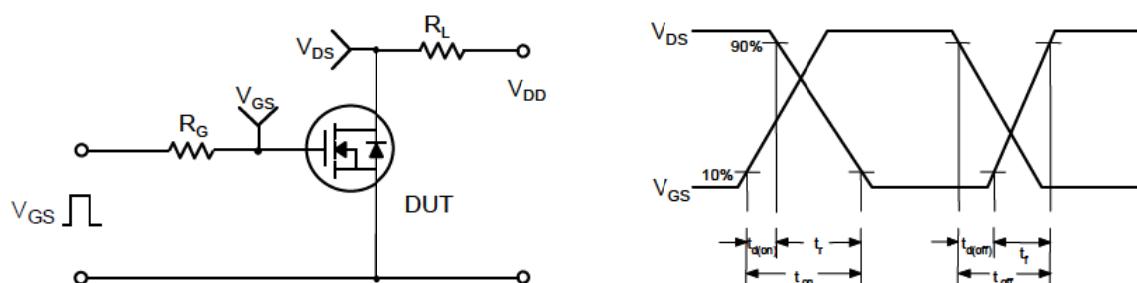
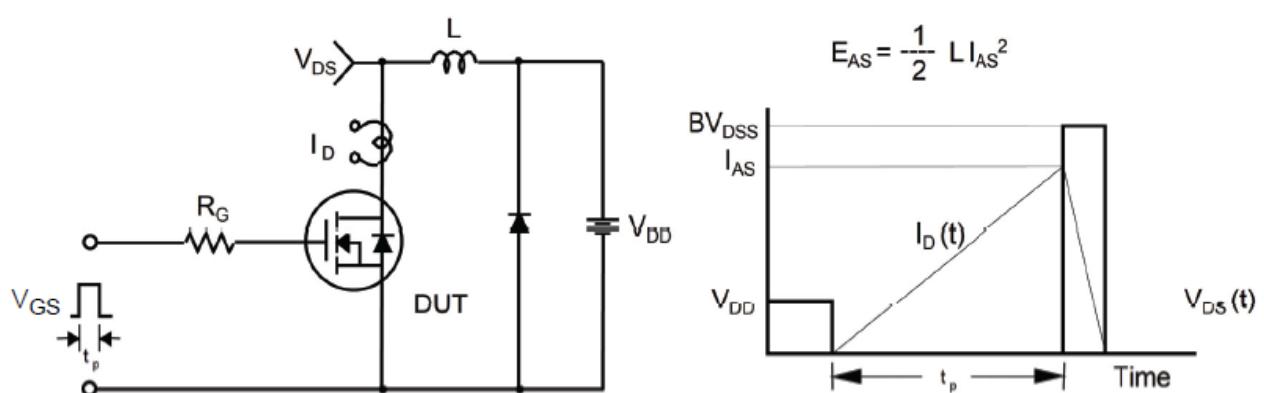
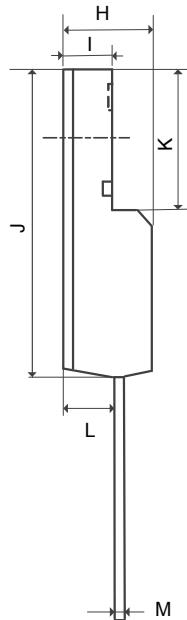
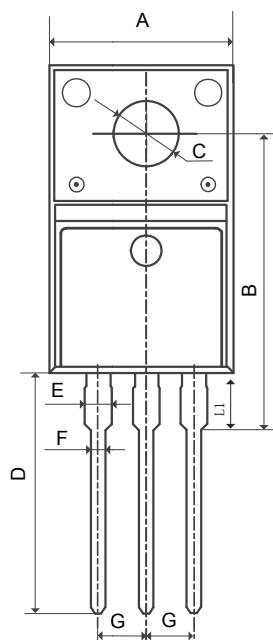
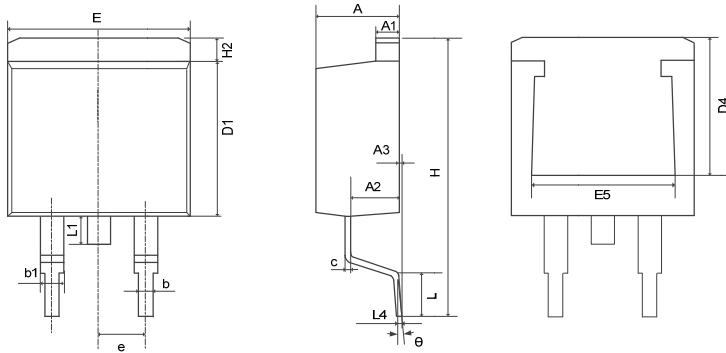


Figure 15. Gate Charge Characteristics

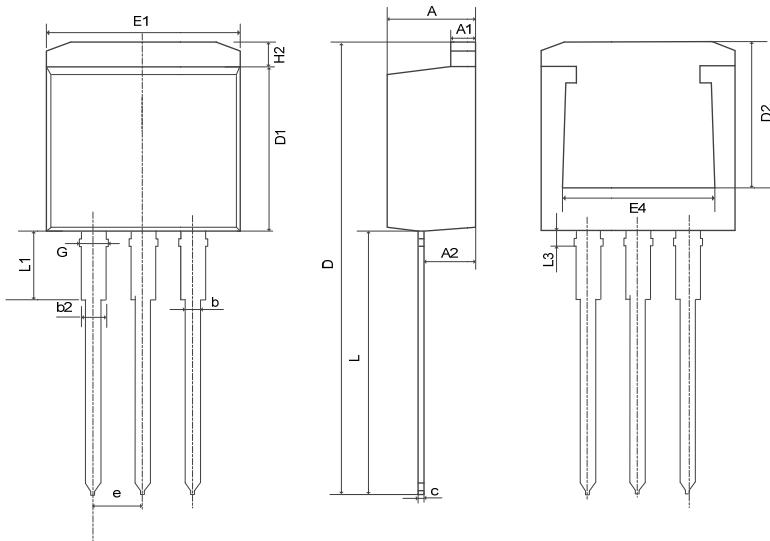
Gate Charge Test Circuit & Waveform**Switching Test Circuit & Waveforms****Unclamped Inductive Switching Test Circuit & Waveforms**

Mechanical Dimensions for TO-220F**COMMON DIMENSIONS**

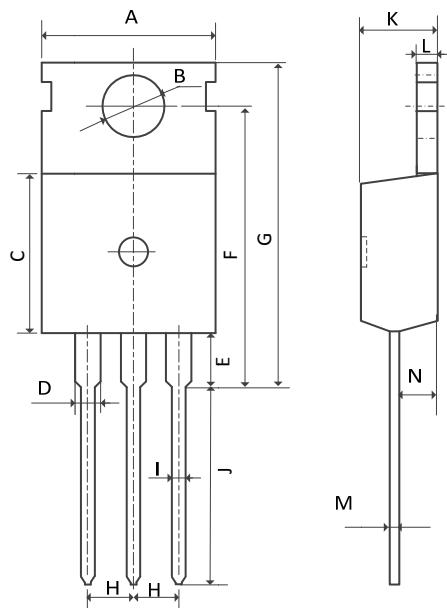
SYMBOL	MM	
	MIN	MAX
A	9.96	10.36
B	15.10	16.10
C	3.03	3.38
D	12.64	13.28
E	1.18	1.58
F	0.70	0.95
G	2.54REF	
H	4.50	4.90
I	2.34	2.74
J	15.57	16.17
K	6.70REF	
L	2.56	2.96
M	0.40	0.65
L1	2.85	3.45

Mechanical Dimensions for TO-263**COMMON DIMENSIONS**

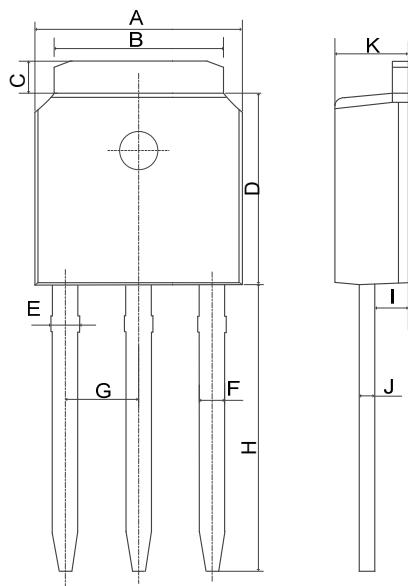
SYMBOL	MM	
	MIN	MAX
A	4.37	4.89
A1	1.17	1.42
A2	2.49	2.89
b	0.70	0.96
b1	1.17	1.47
c	0.30	0.53
D1	8.45	8.90
D4	6.60	—
E	9.86	10.40
E5	7.06	—
e	2.54BSC	
H	14.70	15.50
H2	1.07	1.47
L	2.00	2.70
L1	1.40	1.70
L4	0.25BSC	
θ	0°	9°

Mechanical Dimensions for TO-262**COMMON DIMENSIONS**

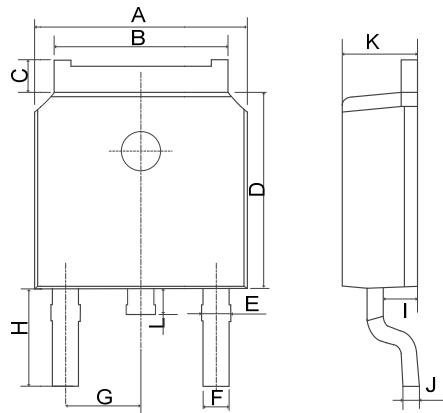
SYMBOL	MM	
	MIN	MAX
A	4.37	4.90
A1	1.17	1.42
A2	2.49	2.89
b	0.71	0.96
b2	1.07	1.47
c	0.28	0.53
D	23.20	24.02
D1	8.45	8.90
D2	6.00	—
E1	9.86	10.40
E4	7.06	—
e	2.54BSC	
G	1.25	1.50
H2	—	1.50
L	13.33	14.16
L1	3.50	4.00
L3	1.28	1.58

Mechanical Dimensions for TO-220**COMMON DIMENSIONS**

SYMBOL	MM	
	MIN	MAX
A	9.70	10.20
B	3.40	3.80
C	8.90	9.40
D	1.17	1.47
E	2.60	3.40
F	15.10	16.70
G	19.55MAX	
H	2.54REF	
I	0.70	0.95
J	9.35	11.00
K	4.30	4.77
L	1.20	1.45
M	0.40	0.65
N	2.20	2.60

Mechanical Dimensions for TO-251**COMMON DIMENSIONS**

SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.13	5.50
C	0.88	1.28
D	5.90	6.22
E	0.68	1.10
F	0.68	0.91
G	2.29REF	
H	9.00	9.65
I	0.85	1.17
J	0.40	0.61
K	2.10	2.50

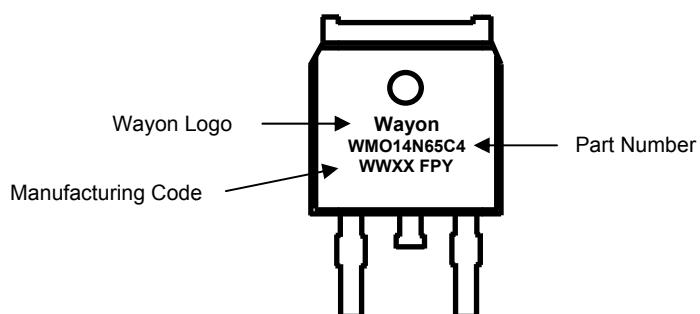
Mechanical Dimensions for TO-252**COMMON DIMENSIONS**

SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.13	5.50
C	0.88	1.28
D	5.90	6.22
E	0.68	1.10
F	0.68	0.91
G	2.29REF	
H	2.90REF	
I	0.85	1.17
J	0.51REF	
K	2.10	2.50
L	0.40	1.00

Ordering Information

Part	Package	Marking	Packing method
WML14N65C4	TO-220F	WML14N65C4	Tube
WMK14N65C4	TO-220	WMK14N65C4	Tube
WMN14N65C4	TO-262	WMN14N65C4	Tube
WMM14N65C4	TO-263	WMM14N65C4	Tape and Reel
WMO14N65C4	TO-252	WMO14N65C4	Tape and Reel
WMP14N65C4	TO-251	WMP14N65C4	Tube

Marking Information



Contact Information

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WAYON website: <http://www.way-on.com>

For additional information, please contact your local Sales Representative.

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